SN54F245, SN74F245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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- 3-State Outputs Drive Bus Lines Directly
- Package Options Include Plastic Small-Outline (SOIC) and Shrink Small-Outline (SSOP) Packages, Ceramic **Chip Carriers, and Plastic and Ceramic** DIPs

description

These octal bus transceivers are designed for asynchronous communication between data buses. The devices transmit data from the A bus to the B bus or from the B bus to the A bus depending upon the logic level at the direction-control (DIR) input. The output enable (\overline{OE}) input can be used to disable the device so the buses are effectively isolated.

The SN74F245 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54F245 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74F245 is characterized for operation from 0°C to 70°C.

SN54F245 J PACKAGE
SN74F245 DB, DW, OR N PACKAGE
(TOP VIEW)

SN54F245 ... FK PACKAGE (TOP VIEW)



FUNCTION TABLE

INP	UTS	OPERATION			
OE	DIR	OPERATION			
L	L	B data to A bus			
L	Н	A data to B bus			
Н	Х	Isolation			



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logic symbol[†]



logic diagram (positive logic)



To Seven Other Channels

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC}	
Input current range	mA to 5 mA
Voltage range applied to any output in the disabled or power-off state $\dots \dots \dots$	5 V to 5.5 V
Voltage range applied to any output in the high state).5 V to V _{CC}
Current into any output in the low state: SN54F245 (A1 thru A8)	40 mA
SN54F245 (B1 thru B8)	96 mA
SN74F245 (A1 thru A8)	48 mA
SN74F245 (B1 thru B8)	128 mA
Operating free-air temperature range: SN54F245	°C to 125°C
SN74F245	0°C to 70°C
Storage temperature range	°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



recommended operating conditions

			SN54F245			SN74F245			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V	
VIL	Low-level input voltage			0.8			0.8	V	
IIК	Input clamp current			-18			-18	mA	
1	High-level output current	A1 thru A8			- 3			- 3	mA
ЮН	High-level output current	B1 thru B8			- 12			- 15	mA
1.0.1		A1 thru A8			20			24	mA
IOL	Low-level output current B1 thru B				48			64	ma
ТА	Operating free-air temperature		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		s	N54F24	5	SN74F245			LINUT		
		TEST CONDITIONS			TYP†	MAX	MIN	TYP†	MAX	UNIT		
		V _{CC} = 4.5 V,	lj = -18 mA			-1.2			-1.2	V		
	A1 thru A8	A1 thru A9		V _{CC} = 4.5 V	I _{OH} = – 1 mA	2.5	3.4		2.5	3.4		
		VCC = 4.5 V	I _{OH} = – 3 mA	2.4	3.3		2.4	3.3				
∨он	B1 thru B8	V _{CC} = 4.5 V	I _{OH} = – 12 mA	2	3.2					V		
	BT tillt Bo	VCC = 4.5 V	I _{OH} = – 15 mA				2	3.1				
	Any output	V _{CC} = 4.75 V,	$I_{OH} = -1 \text{ mA to} - 3 \text{ mA}$				2.7					
	A1 thru A8	V _{CC} = 4.5 V	I _{OL} = 20 mA		0.3	0.5						
VOL		VCC = 4.5 V	I _{OL} = 24 mA					0.35	0.5	v		
	B1 thru B8	V _{CC} = 4.5 V	I _{OL} = 48 mA		0.38	0.55				v		
			I _{OL} = 64 mA					0.42	0.55			
i.	A and B	V _{CC} = 5.5 V	VI = 5.5 V			1			1	mA		
Ι	DIR, OE	VCC = 5.5 V	V _I = 7 V			0.1			0.1			
. +	A and B	V _{CC} = 5.5 V,				70			70	μA		
чн‡	DIR, OE	VCC = 5.5 V,	V _I = 2.7 V			20			20	μΑ		
. +	A and B	V _{CC} = 5.5 V,				-0.65			-0.65	mA		
'⊪_‡	DIR, OE	VCC = 5.5 V,	V _I = 0.5 V			- 1.2			- 1.2	MA		
losÿ	A1 thru A8		$\lambda = 0$	-60		-150	-60		-150	mA		
	B1 thru B8	V _{CC} = 5.5 V,	$V_{O} = 0$	-100		-225	-100		-225	mA		
			Outputs high		70	90		70	90			
ICC		$V_{CC} = 5.5 V$	Outputs low		95	120		95	120	mA		
			Outputs disabled		85	110		85	110			

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.
[‡] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.
§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.



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switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	Cl Rl	C = 5 V = 50 pl = 500 9 = 500 9 = 25°C	F, Ω,	CL RL	= 50 pF = 500 Ω			UNIT	
			′F245		SN54F245		SN74F245				
			MIN	TYP	MAX	MIN	MAX	MIN	MAX		
^t PLH	A or B	B or A	1.7	3.8	6	1.2	7.5	1.7	7	ns	
^t PHL	AUD		Born	Borra	1.7	4.2	6	1.2	7.5	1.7	7
^t PZH	OE	A or B	2.2	4.9	7	1.7	9	2.2	8	ns	
^t PZL	ÛE	AOIB	2.7	5.6	8	2.2	10	2.7	9	115	
^t PHZ	ŌĒ	A or B	2.2	4.6	6.5	1.7	9	2.2	7.5	20	
^t PLZ	UL UL		1.2	4.6	6.5	1.2	10	1.2	7.5	ns	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: Load circuits and waveforms are shown in Section 1.



28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
85511012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
8551101RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
8551101SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
JM38510/34803B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/34803BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/34803BSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SN54F245J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN74F245DBLE	OBSOLETE	SSOP	DB	20		None	Call TI	Call TI
SN74F245DBR	ACTIVE	SSOP	DB	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74F245DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74F245DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74F245N	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74F245N3	OBSOLETE	PDIP	Ν	20		None	Call TI	Call TI
SN74F245NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54F245FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54F245J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54F245W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

28-Feb-2005

to Customer on an annual basis.

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